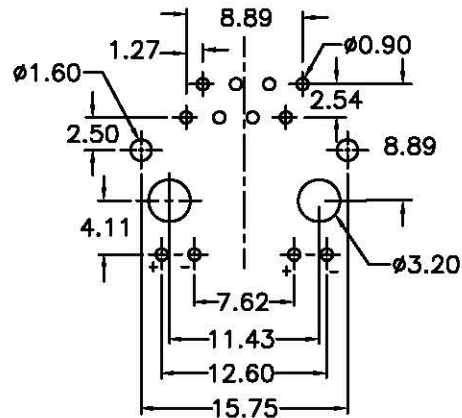
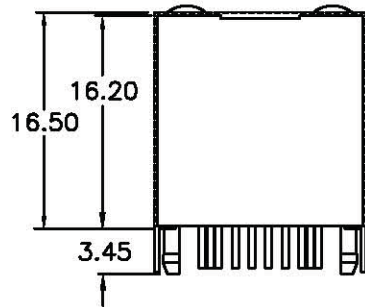
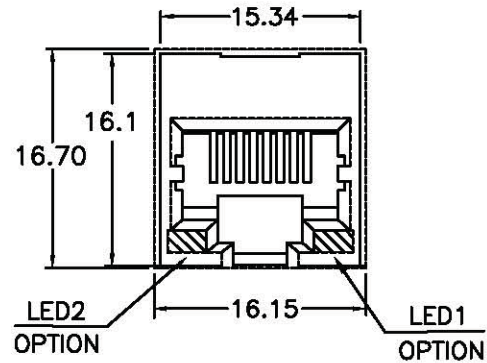
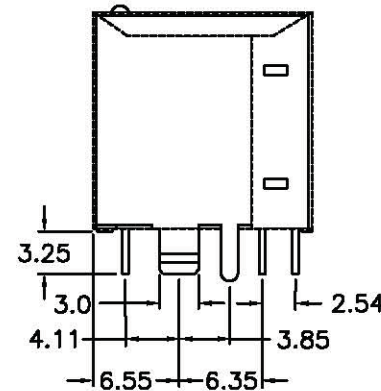


REV.	SPECIFICATION	ECN NO.	APPD.



P.C.B Layout



Material:

Housing & Led: Thermoplastic Polyester Glass Filled UL94V-0.

Contacts: Copper Alloy.

Shield: Copper Alloy.

Plating: Selective Gold plated on contact area over Nickel.

Electrical Characteristics:

Current Rating: 1.5 AMP.

Insulator Resistance: 1000MΩ min. at DC 500V.

Contact Resistance: 30mΩ max. at DC 100mA.

Operating Temperature: -40°C~+85°C.

***ROHS Compliant**

8949-H1	8	8	/06
Series	Pos.	8: 8 Pin 6: 6 Pin 4: 4 Pin 2: 2 Pin	06: 06 μ Gold Plated 15: 15 μ Gold Plated 30: 30 μ Gold Plated 50: 50 μ Gold Plated

SE0
SE0: SE0 Type Blank: Non - Shield

A	B	A
A: LED1: Green, LED2: Yellow B: LED1: Green, LED2: Green C: LED1: Yellow, LED2: Green D: LED1: Yellow, LED2: Yellow E: LED1: G+Y, LED2: Green	B: Black	A: Tray Package

Tolerances	Dwg. No.	8949D02118
x = ± 0.5	Projection	
.x = ± 0.25	Unit	mm
.xx = ± 0.15	Scale	1:1
	Drawn By	Peggy09/07'11

Title:
8949-H1 Series Modular Jack With LED

	Mega-Chip Electronics Pte Ltd
P/N:	8949-H188/06SE0ABA
SHEET	1/1
Ver.No.	A3